



Part Number: - SI003

True Wire Bond Region

Introduction:-

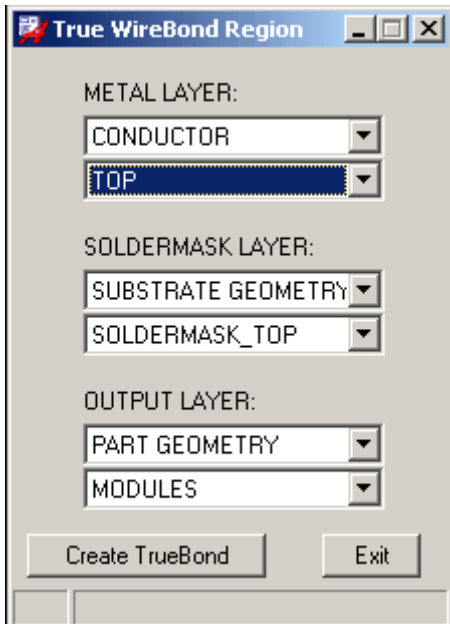
In Package Design, Wire Bond diagram need True Bond region, which is basically a Gold plated metal areas. It's often spend days to create such diagram manually by using AutoCad or other drafting tools. This program will create as a shapes of all the Metal opening including trace, vias, pins & shapes.

Features:-

1. Users selectable soldermask, Metal & Output layers
2. Output is created as a Shape
3. Metal layer supported for trace, vias, pins & shapes.

GUI:-

GUI will allow user to select, Metal layer, Soldermask layer & output layer where true wirebond region shapes need to be created.

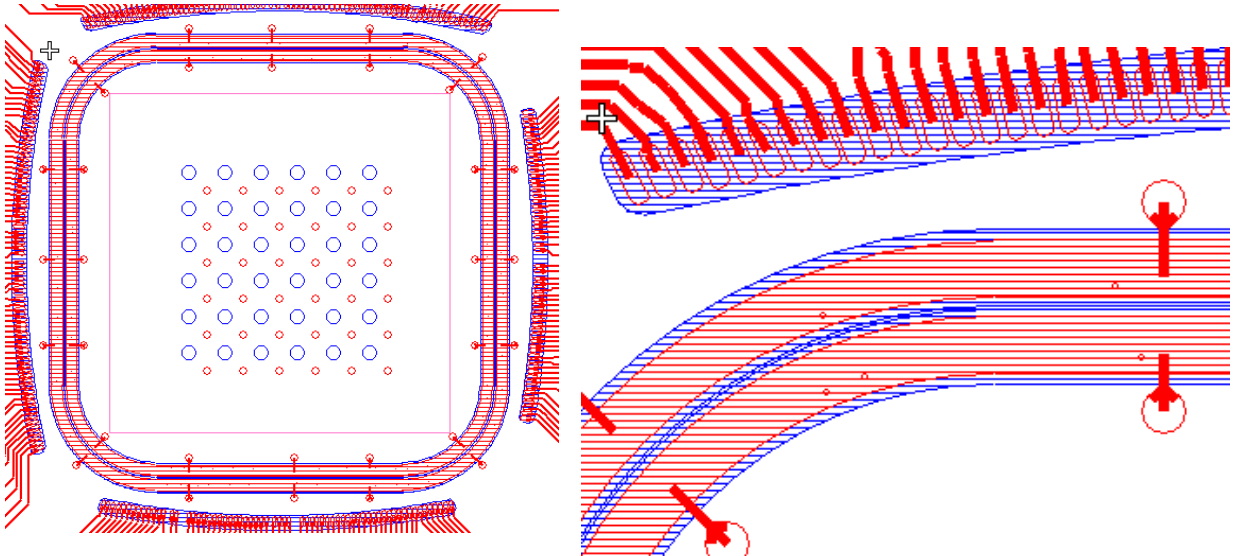


Output:-

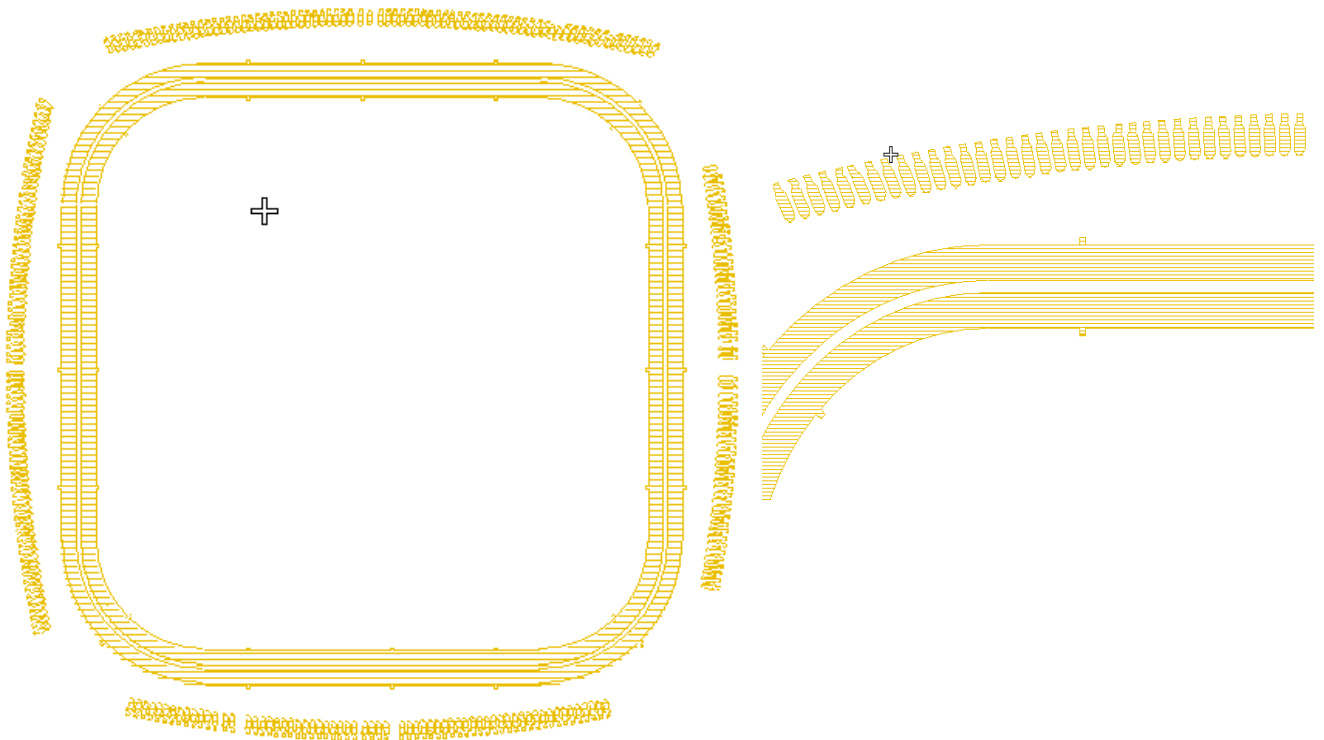
This program will create true wirebond regions in the output layer.



Actual Design:-



True Wirebond Region:-



Contact details:-

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